

Notice of References Cited	Application/Control No. 09/444,675		Applicant(s)/Patent Under Reexamination KOIZUMI ET AL.	
	Examiner Heather R. Jones		Art Unit 2615	Page 1 of 1

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*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
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*	C	US-6,184,516	02-2001	Sawada et al.	250/214.1
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*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)
Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.